

ENHANCED PLASMA ABLATION (EPA)

- *EVAPORATION OF ALMOST EVERY MATERIAL POSSIBLE*
- *COST EFFECTIVE PRICING*
- *HIGH VACUUM DESIGN*
- *RUGGED IN CONSTRUCTION*

Essentially EPA is a new process in which a highly energized plasma beam sublimes some microns of a solid or liquid target in few nanoseconds.

EPA, because of its unique characteristics, is emerging as a popular physical vapor deposition (PVD) technique to grow a wide variety of chemically and structurally complex materials.

Because all the segment of the target is ablated in few nanoseconds into an energetic plume of material, the target stoichiometry is usually transferred readily to the substrate.

This process also has high kinetic and internal energy of the ablated species and the ability to operate in a variety of background gases over a very wide pressure range (from 3 to 10E-5mbar)

In the past similar techniques have been used for the production of high quality thin films of several complex materials that would be difficult or impossible by conventional PVD or chemical vapor deposition (CVD) techniques. Because of the high forward directionality of the ablated plume in EPA, scale-up of this process to coat substrates of useful size was once considered doubtful. However, different approach has been developed to uniformly cover large areas. Deposition over substrates up to 200mm have been demonstrated with a uniformity in thickness maintained below of $\pm 5\%$.



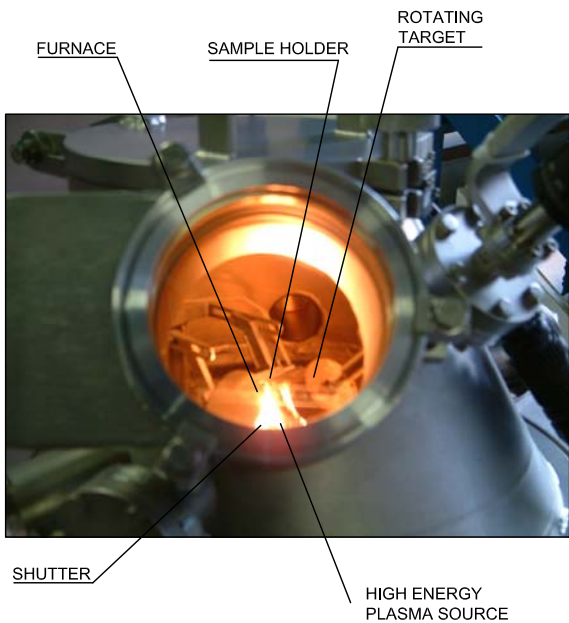
Practically all materials may be evaporated: the main feature of EPA is to produce high power density at the target surface (10^8 W/mm²) comparable to pulsed laser deposition (PLD), but the PLD process is critically dependent on the optical absorption coefficient of the target material.

SiO₂ with a large band gap of 10eV for example, is transparent to the excimer laser radiation; in EPA technique, however, the high-power electrons may strongly couple to the SiO₂ target, leading to SiO₂ film deposition.

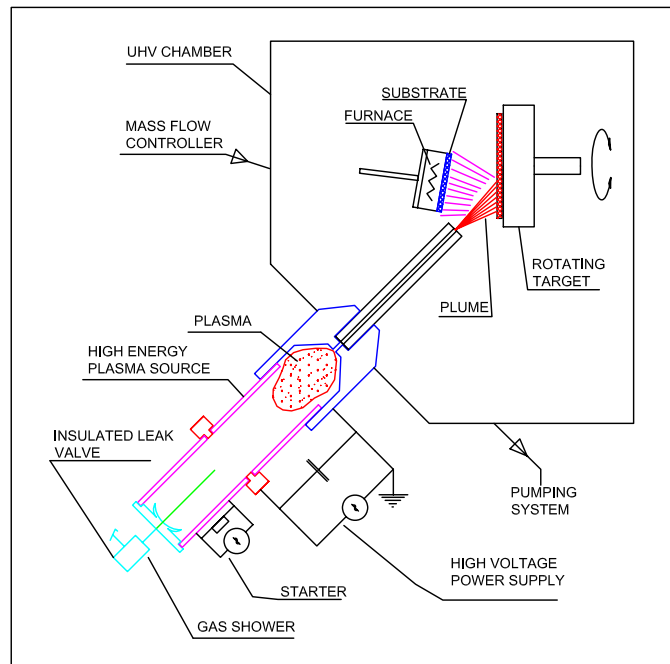
EPA system is able to deposit conducting and not conducting materials with deposition rates ranging from 0.01 Å/pulse up to about 100 Å/pulse. Additional modification, like cathode and target cooling and others could significantly increase the deposition/ablation rates by, perhaps, order of magnitude.

With EPA, reduction of energy consumption cost of 2 order of magnitude is verified while the installation costs are more than 5 times cheaper than commercial PLD setups.

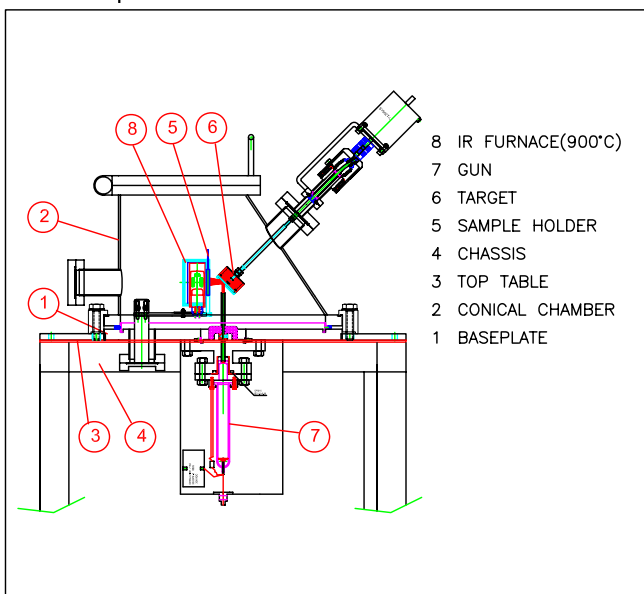
View through DN100 hublot



Principle scheme



IBCO Deposition chamber



APPLICATIONS

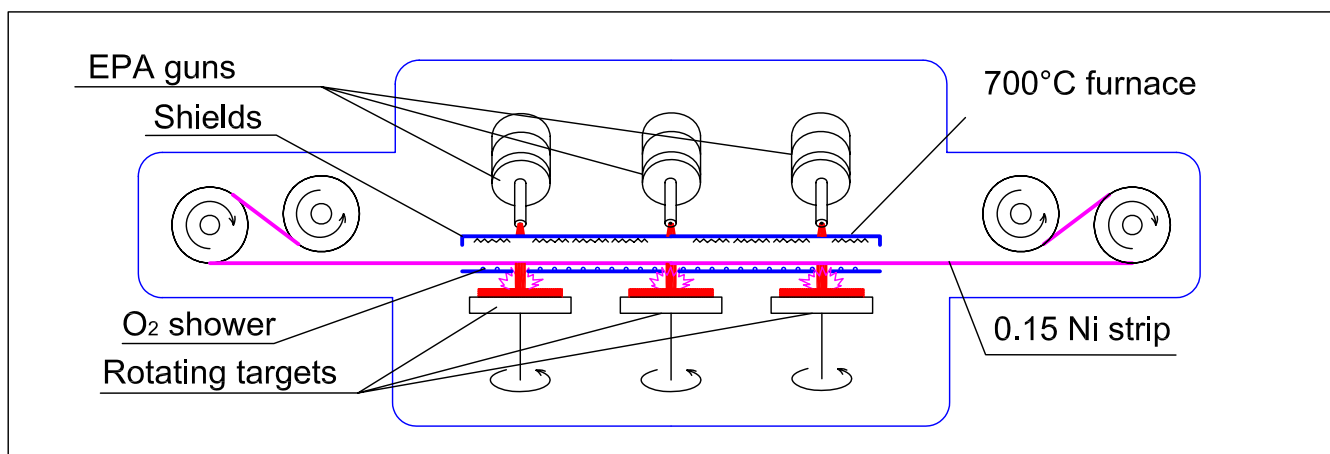
Colossal Magnetoresistance Manganites are an example of good results in deposition of epitaxial superconducting or ferromagnetic films with EPA technique.

Buffer oxide layers in a wide variety have been obtained, replacing laser ablation in thin film technology.

Other examples of representative materials produced by EPA:

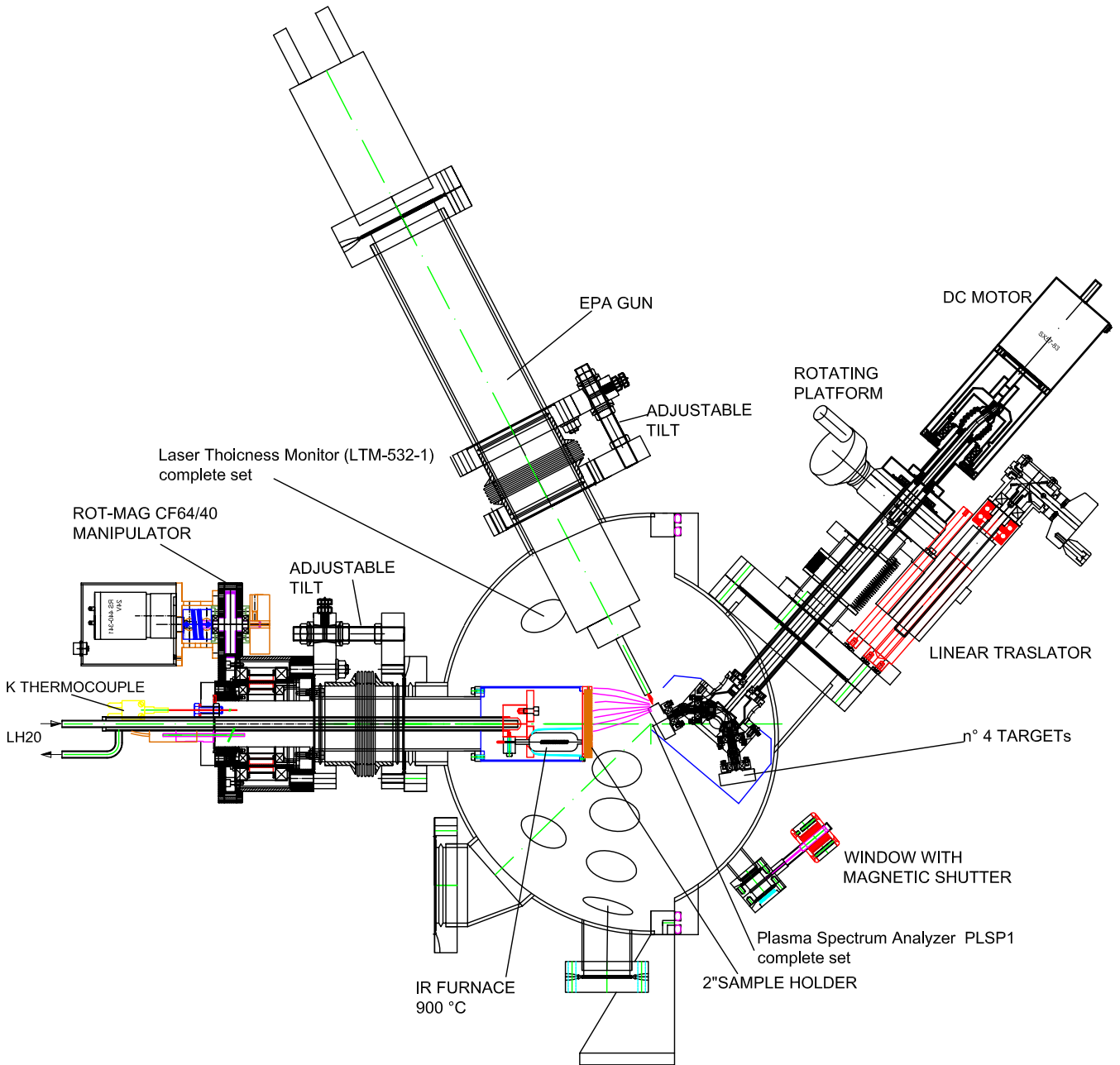
- YBCO, GdBCO high temperature superconducting films (operating temperatures at 90K are known)
- BaSrTiO₃ films
- SiO₂ compounds and Al₂O₃ ceramic oxide films

Thermovoltaic systems, SWCNT nanotubes, photonics materials are investigating this new technology.



ROLL TO ROLL SYSTEM for superconducting coating on nichel strip

CHAMBER OF SiC SYSTEM



EPA-5 2"sample holder-1kW IR furnace



Power supplies and controls for target

EPA-1 SYSTEM

EPA-1 System has been designed to indagate and produce a wide range of materials as high temperature oxides, complex alloys ,organic compounds. This ablation process generates a good stoichiometric deposition.

SPECIFICATIONS

Chamber

size: spheical shape, DN350 base flange
 quick port for sample operations
 operating pressure: 2×10^{-2} to 2×10^{-5} mbar
 lead glass DN100 viewport with magnetic shutter
 sample shutter with push-pull translator

Substrate

heater: max temperature 800°C
 temperature uniformity: better than 2°C
 diam surface: 25/50mm
 adjustable support structure
 temp measurement: thermocouple K
 temp controller: programmable auto-tuning
 PID temperature controller

Plasma source

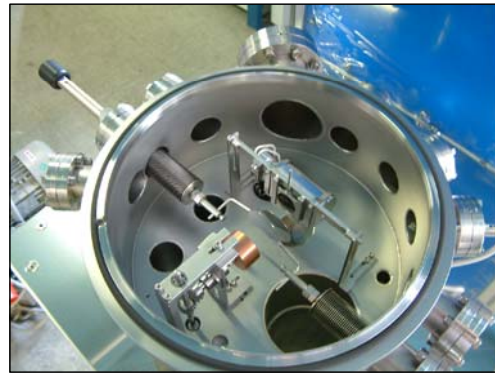
power supply: 230V-50Hz-single phase
 DC voltage: 8 - 25kV
 operating pressure: 2×10^{-2} to 2×10^{-5} mbar
 power pulse density: 4 - 600MW/cm²
 max repetition rate: 100Hz
 ablation depth: 0.5 - 2 micron
 gas inlet: 2 - 100 scc/min

Target

1" diam rotating target
 option: 4 x 1" diam targets
 rotation speed: 0-30rpm
 deposition rate: 100/2000Angstrom/minute

Gas manifold

mass flow controller: 2 - 100 scc/min
 single channel display and control



Superconductor film chamber

Vacuum system

70 l/s turbodrag pump
 16 m³/h rough pump with trap
 vent valve for purge
 pirani/penning vacuum gauge

System frame

Bosch Al profiled with levelers
 sizes: length 1166mm
 width 578mm
 height 1160±50mm
 power: single phase 230VAC - 50Hz - 20A

SPECIAL DESIGN

VACUO in collaboration with CNR laboratories and OS continues to expand the application of EPA to improve production of advanced materials as superconductors, SiC, peroskvites, SWCNT, oxides, organic materials.

Please contact VACUO for specific infomations on new processes and research machines.



Tilt-rotating target-magnetically coupled

COMPARISON BETWEEN EPA AND OTHER METHODS

	Stoichiometric transfer	Chemical purity	Deposition rate variability	Flexibility to target material choice
EPA Enhanced Plasma Ablation	good	good	good	good
Magnetron sputtering	bad	good	good	good
PLD Pressure Liquid Deposition	good	good	bad	bad
CVD Chemical Vapor Deposition	good	bad	bad	very bad

MATERIALS DEPOSITED BY ENHANCED PLASMA ABLATION

1. High - T_c superconductors: $\text{YBa}_2\text{Cu}_3\text{O}_7$, $\text{SmBa}_2\text{Cu}_3\text{O}_7$, $\text{GdBa}_2\text{Cu}_3\text{O}_7$

Main achievements:

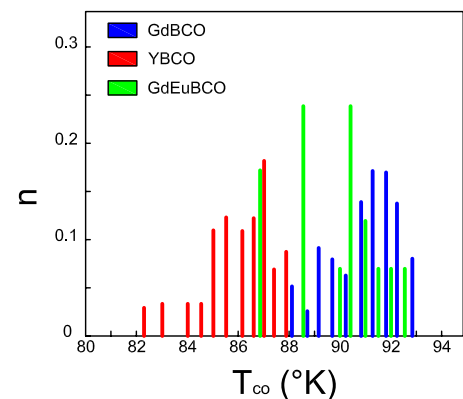
$T_{co} > 92^\circ\text{K}$, $I_c = 2 - 4 \times 10^6 \text{ A/cm}^2$

Ultrafast deposition rate: 60 \AA/s

Direct growth of superconducting films on Ni tapes

Distribution of the zero resistance T_c over a statistical sample of 106 films deposited in one month. n is the number of films showing

$-0.5\text{K} < T_c < +0.5\text{K}$ divided by 106

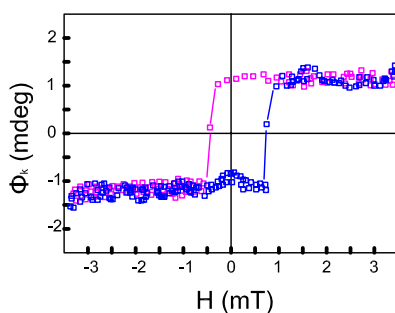
2. Colossal Magnetoresistance Manganite films ($\text{La}_x\text{Sr}_{1-x}\text{MnO}_3$, $\text{La}_x\text{Ca}_{1-x}\text{MnO}_3$, $\text{Pr}_x\text{Ca}_{1-x}\text{MnO}_3$) on various substrates: NdGaO_3 , SrTiO_3 , Si, SiO_x , and GaAs

Main achievements:

$T_{\text{Curie}} = 350\text{K}$, 100% Spin Polarisation at room temperature in $\text{La}_x\text{Sr}_{1-x}\text{MnO}_3$

$\text{La}_x\text{Sr}_{1-x}\text{MnO}_3$ and $\text{La}_x\text{Ca}_{1-x}\text{MnO}_3$ successfully used in OLEDs

Prototype of memory elements $\text{La}_x\text{Sr}_{1-x}\text{MnO}_3$ - organic - $\text{La}_x\text{Sr}_{1-x}\text{MnO}_3$ fabricated



MOKE - Room Ferromagnetism



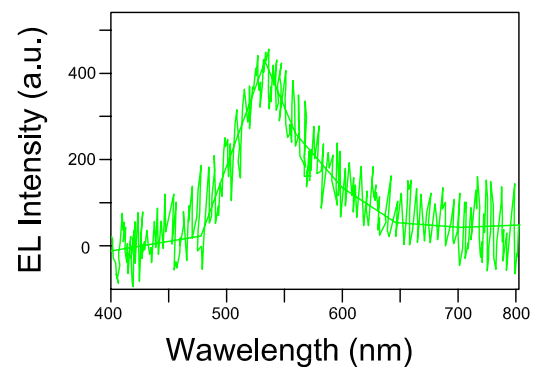
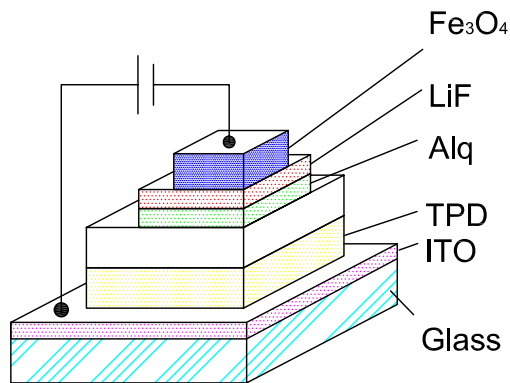
LN2 sample holder and 4 target

3. Magnetite FeO_4 films on both inorganic and organic substrates

Main achievements:

First time deposition of high quality magnetite films directly on layers of organic semiconductors for spintronics applications

First demonstration of working OLED with top magnetite electrode



4. Various simple and double oxides (AlO_x, TiO_x, CeO_x, SrTiO₃, NdGaO₃)

Main achievements:

Epitaxial growth of SrTiO₃ and NdGaO₃ on perovskite substrates

High density for AlO_x ultra thin films for FET applications:

leak currents less than 10⁻⁹ A at 100 V for 10 nm thick layers

5. Hard coating SiC

Main achievements:

High ablation rate

Surface hardness of about 50% of the single crystal values

6. Transparent conducting oxides (TCO), IMO,

7. Organic materials: Teflon, Polyethylene,

8. Thin film depositions performed by EPA

- CdS
- CdTe
- ZnO
- WC
- HfO₂
- GaN
- In₂O₃
- ZrO₂
- SiO₂
- AlO₂
- TiO₂
- ZnO;Al₂O₃
- Al
- W
- Cu
- Ti
- Stainless Steel
- Polyethylene

DEVELOPED EPA SYSTEM FOR INDUSTRIAL APPLICATION

Extremely high deposition rate

High film thickness homogeneity

Low temperature deposition capability on plastic or "heat degrading" materials

Wide area implementation deposition system

Easy integration of EPA-GUNs module in thin films industrial production line

Safe and sustainable fabrication process